

## FGZ50N65WE

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**Discrete IGBT** 

# Discrete IGBT (High-Speed W series) 650V / 50A

#### Features

Low power loss Low switching surge and noise High reliability, high ruggedness (RBSOA, SCSOA etc.)

#### Applications

Uninterruptible power supply PV Power conditioner Inverter welding machine



#### **■** Equivalent circuit

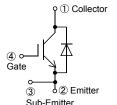
#### ■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings at T<sub>vi</sub>=25°C (unless otherwise specified)

Items	Symbol	Characteristics	Unit	Remarks
Collector-Emitter Voltage	Vces	650	V	
Gate-Emitter Voltage	V <sub>GES</sub>	±20	V	
Transient Gate-Emitter Voltage		±30		T₂<1µs
DC Collector Current	Ic@25	70	Α	<i>T</i> <sub>c</sub> =25°C
DC Collector Current	/c@100	50	Α	<i>T</i> c=100°C
Pulsed Collector Current	I <sub>CP</sub>	200	Α	Note *1
Turn-Off Safe Operating Area	-	200	Α	V <sub>CE</sub> ≤650V, T <sub>vj</sub> ≤175°C
Diode Forward Current	/F@25	73	Α	
	I <sub>F@100</sub>	50	Α	
Diode Pulsed Current	I <sub>FP</sub>	200	Α	Note *1
IGBT Max. Power Dissipation	$P_{D\_IGBT}$	330	W	<i>T</i> <sub>c</sub> =25°C
FWD Max. Power Dissipation	P <sub>D_FWD</sub>	170	W	<i>T</i> <sub>c</sub> =25°C
<b>Operating Junction Temperature</b>	T <sub>vj</sub>	-40 ~ +175	°C	
Storage Temperature	T <sub>stg</sub>	-55 ~ +175	°C	



TO-247-4L



Note \*1 : Pulse width limited by Tvjmax.

● Electrical characteristics at T<sub>vj</sub>= 25°C (unless otherwise specified) Static Characteristics

Description	Symbol	Conditions		min.	typ.	max.	Unit
Zero Gate Voltage Collector Current		V = 650V V = 0V   T <sub>vj</sub> =25°C	-	-	250	uA	
Zero Gate Voltage Collector Current	/ces	$V_{CE} = 650 \text{V}, \ V_{GE} = 0 \text{V}$	T <sub>vj</sub> =175°C	-	-	2	mA
Gate-Emitter Leakage Current	I <sub>GES</sub>	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	200	nA
Gate-Emitter Threshold Voltage	V <sub>GE (th)</sub>	$V_{CE} = 20V, I_{C} = 50mA$		3.0	4.0	5.0	V
			T <sub>vj</sub> =25°C	-	1.80	2.20	
Collector-Emitter Saturation Voltage	V <sub>CE (sat)</sub>	$V_{\rm GE} = 15 \text{V}, I_{\rm C} = 50 \text{A}$	T <sub>vj</sub> =125°C	-	2.05	-	V
			T <sub>vj</sub> =175°C	-	2.10	-	
Input Capacitance	Cies	V <sub>CE</sub> =25V		-	3650	-	
Output Capacitance	Coes	V <sub>GE</sub> =0V		_	105	-	pF
Reverse Transfer Capacitance	Cres	f=1MHz		-	80	-	
Gate Charge	Q <sub>G</sub>	$V_{cc} = 520V$ $I_{c} = 50A$ $V_{GE} = 15V$		-	215	-	nC
Turn-On Delay Time	t <sub>d(on)</sub>			-	26	-	
Rise Time	t <sub>r</sub>	$T_{VJ} = 25^{\circ}\text{C}, V_{CC} = 400\text{V}$ $I_{C} = 25\text{A}, V_{GE} = 15\text{V}$			12	-	20
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{G(on)} = 10\Omega$ , $R_{G(off)} = 20\Omega$	-	350	-	ns	
Fall Time	t <sub>f</sub>		-	23	-		
Turn-On Energy	E <sub>on</sub>	Energy loss include "tail" and FWD reverse recovery.		-	0.12	-	mJ
Turn-Off Energy	E <sub>off</sub>			-	0.40	-	1110
Turn-On Delay Time	$t_{ ext{d(on)}}$	$T_{\text{Vj}}$ = 150°C, $V_{\text{CC}}$ = 400V $I_{\text{C}}$ = 25A, $V_{\text{GE}}$ = 15V $R_{\text{G(of)}}$ = 10 $\Omega$ , $R_{\text{G(off)}}$ = 20 $\Omega$ Energy loss include "tail" and FWD reverse recovery.		-	26	-	
Rise Time	t <sub>r</sub>			-	14	-	ns
Turn-Off Delay Time	$t_{ m d(off)}$			-	390	-	
Fall Time	t <sub>f</sub>			-	16	-	
Turn-On Energy	E <sub>on</sub>			-	0.30	-	mJ
Turn-Off Energy	<b>E</b> off	recovery.		-	0.52	-	1110
			T <sub>vj</sub> =25°C	-	2.5	3.2	V
Forward Voltage Drop	VF	I=50A	T <sub>vj</sub> =125°C	-	1.9	-	V
			T <sub>vj</sub> =175°C	-	1.7	-	V
Diode Reverse Recovery Time	t <sub>rr</sub>	$V_{\text{CC}}$ =400V, $I_{\text{F}}$ = 25A		-	115	-	ns
Diode Reverse Recovery Charge	Qrr	-d <i>i</i> ⊧/d <i>t</i> =500A/µs, <i>T</i> <sub>vj</sub> =25°C		-	0.35	-	μC
Diode Reverse Recovery Time	<b>t</b> rr	Vcc=400V, I <sub>F</sub> =25A		-	140	-	ns
Diode Reverse Recovery Charge	Qrr	-d <i>i</i> ⊧/d <i>t</i> =500A/µs, <i>T</i> <sub>vj</sub> =150°C	;	-	1.10	-	μC

FGZ50N65WE Discrete IGBT

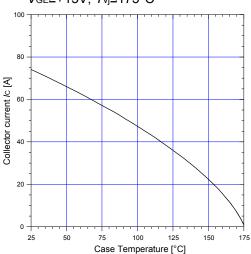
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#### ● Thermal Resistance

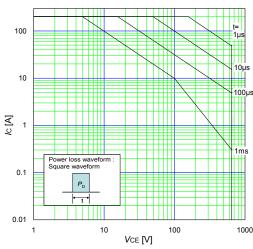
Description	Symbol	min.	typ.	max.	Unit
Thermal Resistance, Junction-Ambient	R <sub>th(j-a)</sub>	-	-	50	°C/W
Thermal Resistance, IGBT Junction to Case	R <sub>th(j-c)_IGBT</sub>	-	-	0.448	°C/W
Thermal Resistance, FWD Junction to Case	R <sub>th(j-c)_FWD</sub>	-	-	0.862	°C/W

#### ■ Characteristics (Representative)

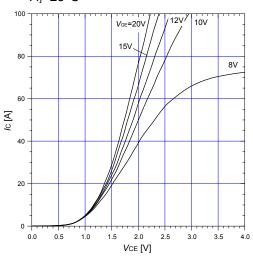
Graph.1 DC Collector Current vs Tc V<sub>GE</sub>≥+15V, T<sub>Vj</sub>≤175°C



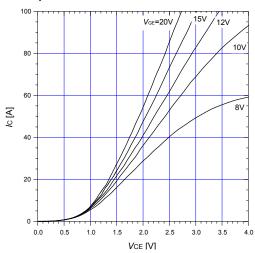
Graph.2 SOA Duty=0(Single pulse), *T*c=25°C



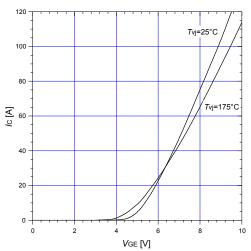
Graph.3
Typical Output Characteristics ( $V_{CE-IC}$ )  $T_{Vj}$ =25°C



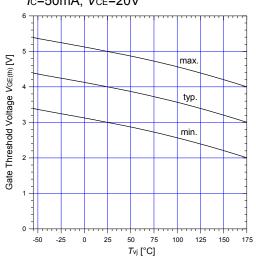
Graph.4
Typical Output Characteristics ( $V_{CE-IC}$ )  $T_{Vj}$ =175°C



Graph.5
Typical Transfer Characteristics
VCE=10V

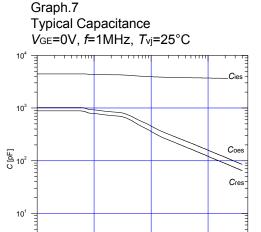


Graph.6 Gate Threshold Voltage vs.  $T_{Vj}$   $I_{C}$ =50mA,  $V_{CE}$ =20V



10<sup>6</sup>

10<sup>-2</sup>

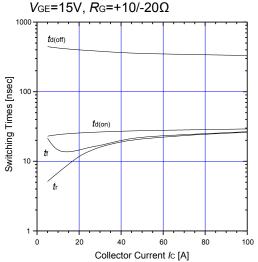


Graph.9
Typical switching time vs. *Ic*  $T_{Vj}$ =150°C,  $V_{CC}$ =400V

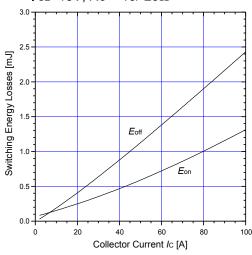
VCE [V]

10<sup>1</sup>

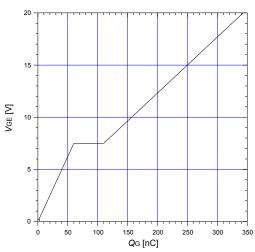
10<sup>-1</sup>



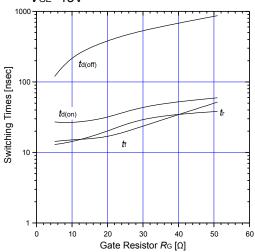
Graph.11 Typical switching losses vs. *Ic*  $T_{Vj}$ =150°C,  $V_{CC}$ =400V  $V_{GE}$ =15V,  $R_{G}$ =+10/-20 $\Omega$ 



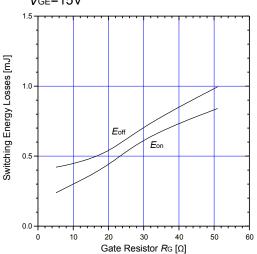
Graph.8 Typical Gate Charge Vcc=520V, Ic=50A, T<sub>Vj</sub>=25°C



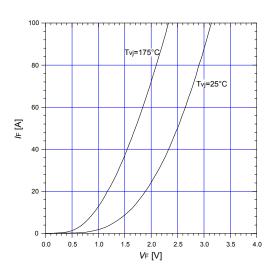
Graph.10
Typical switching time vs. R<sub>G</sub>
T<sub>Vj</sub>=150°C, V<sub>CC</sub>=400V, I<sub>C</sub>=25A
V<sub>GE</sub>=15V



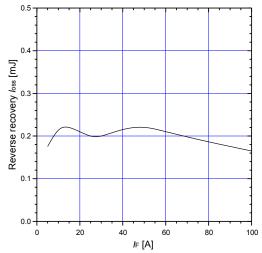
Graph.12
Typical switching losses vs. Ro
Tyj=150°C, Vcc=400V, Ic=25A
VGE=15V



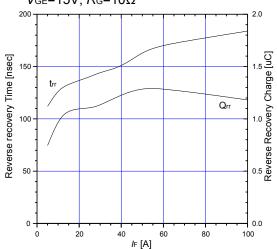
Graph.13 FWD Forward voltage drop (*VF-IF*)



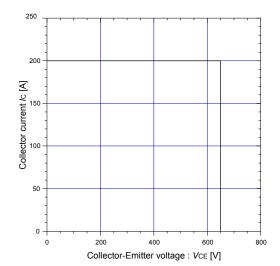
Graph.15 Typical reverse recovery loss vs.  $I_F$  $T_{Vj}$ =150°C,  $V_{CC}$ =400V, L=500 $\mu$ H  $V_{GE}$ =15V,  $R_G$ =10 $\Omega$ 



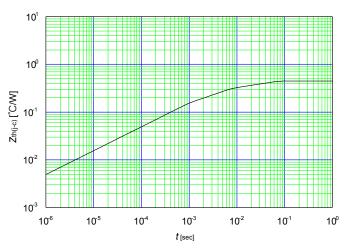
Graph.14
Typical reverse recovery characteristics vs.  $I_F$   $T_{Vj}$ =150°C,  $V_{CC}$ =400V, L=500 $\mu$ H  $V_{GE}$ =15V,  $R_G$ =10 $\Omega$ 



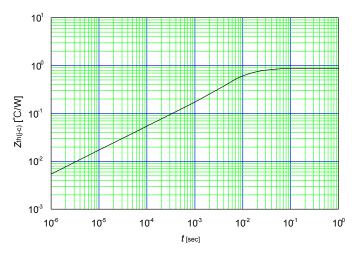
Graph.16
Reverse biased Safe Operating Area  $T_{Vj} \le 175^{\circ}\text{C}$ ,  $V_{GE} = +15 \text{V/0V}$ ,  $R_{G} = 10 \Omega$ 



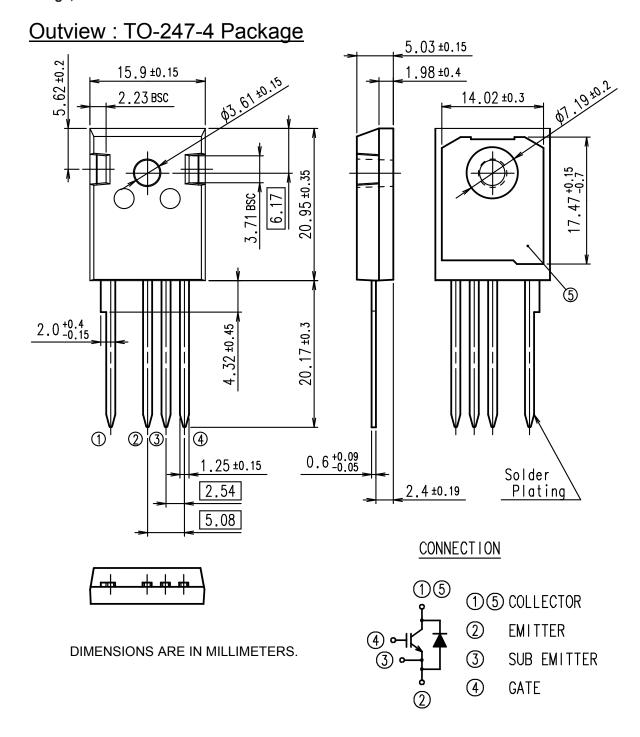
Graph.17
Transient thermal resistance of IGBT



Graph.18
Transient thermal resistance of FWD



### Outline Drawings, mm



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